



Product Change Notification / ALAN-11ELYX284

Date:

06-Jan-2022

Product Category:

32-bit Microcontrollers

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4768 Final Notice: Qualification of ANAP as an additional assembly site for selected Atmel ATSAMG55J19A and ATSAMG55J19B device families available in 64L LQFP (10x10x1.4mm) package.

Affected CPNs:

[ALAN-11ELYX284_Affected_CPN_01062022.pdf](#)
[ALAN-11ELYX284_Affected_CPN_01062022.csv](#)

Notification Text:

PCN Status:Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section.
Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of ANAP as an additional assembly site for selected Atmel ATSAMG55J19A and ATSAMG55J19B device families available in 64L LQFP (10x10x1.4mm) package.

Pre and Post Change Summary:

	Pre Change	Post Change
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Affected Catalog Part Numbers (CPN)

ATSAMG55J19A-AU

ATSAMG55J19B-AU

ATSAMG55J19A-AUT

ATSAMG55J19B-AUT

CCB 4768
Pre and Post Change Summary
PCN# ALAN-11ELYX284



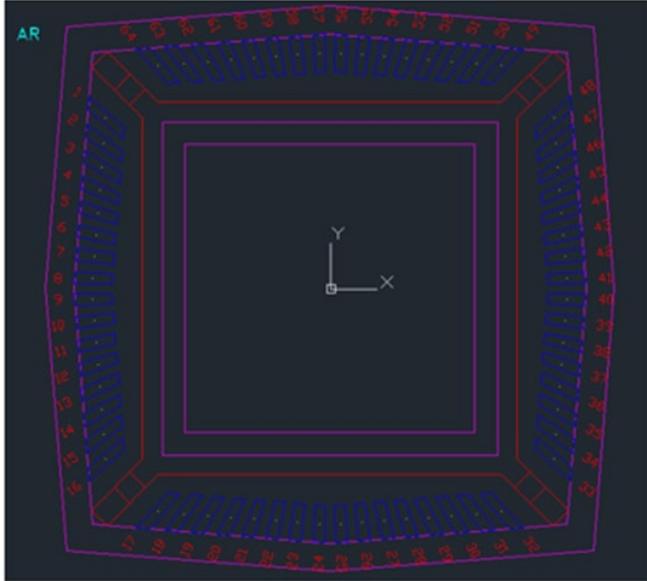
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Pre and Post Change Summary

Pre Change



Assembly location

ASE Inc. (ASE)

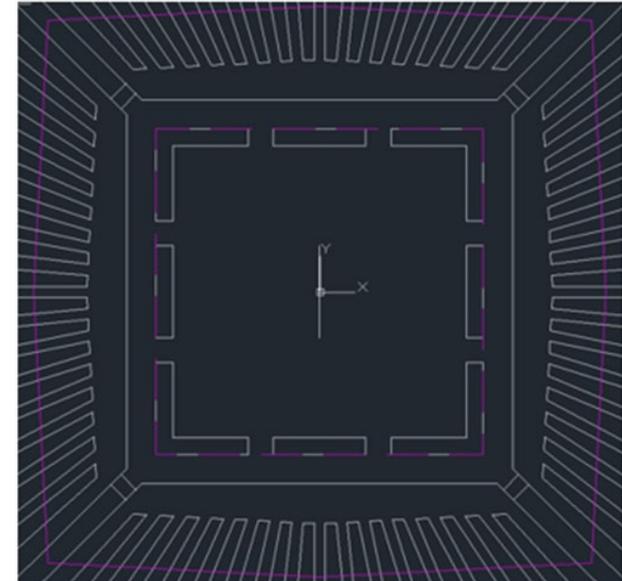
Lead frame material

C7025

Lead frame paddle size

200x200 mils

Post Change



Assembly location

Amkor Technology Philippine
(P1/P2), INC. (ANAP)

Lead frame material

C194

Lead frame paddle size

138x138 mils